

# POLYMER PTC RESETTABLE FUSE

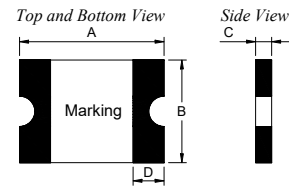


Part Number: TLC-LSMD050/50

## 1、 Physical Dimensions(size of 2920)

Unit:mm

Part Number	A		B		C		D	Marking
	Min	Max	Min	Max	Min	Max	Min	
TLC-LSMD050/50	6.73	7.98	4.80	5.44	0.75	1.25	0.30	T050



## 2、 Electrical Characteristics

Part Number	I <sub>H</sub> (A)	I <sub>T</sub> (A)	V <sub>max</sub> (V)	I <sub>max</sub> (A)	T <sub>trip</sub> (Max time to trip)		Pd <sub>typ</sub> (W)	R <sub>min</sub> (Ω)	R1 <sub>max</sub> (Ω)
					Current(A)	Time(S)			
TLC-LSMD050/50	0.50	1.00	50	10	2.5	3.0	1.5	0.180	1.400

I<sub>H</sub>: Holding Current: maximum current at which the device will not trip in 25°C still air.

I<sub>T</sub>: Tripping Current minimum current at which the device will trip in 25°C still air.

V<sub>max</sub>: Maximum voltage device can withstand without damage at rated current.

I<sub>max</sub>: Maximum fault current device can withstand without damage at rated voltage.

T<sub>trip</sub>: Maximum time to trip(s) at assigned current.

Pd<sub>typ</sub>: Rated working power.

R<sub>min</sub>: Minimum resistance of device prior to trip at 25°C.

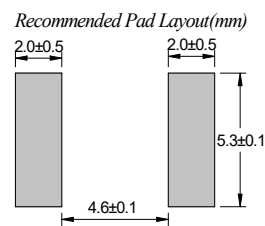
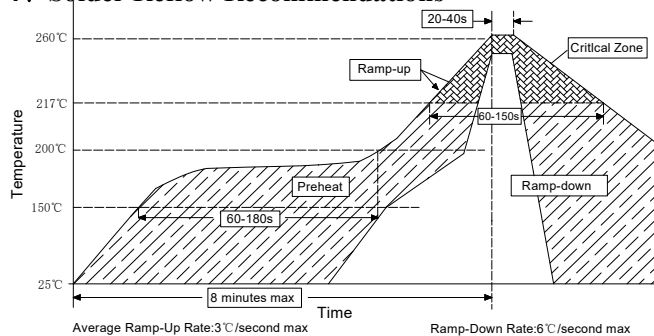
R1<sub>max</sub>: Maximum resistance of device is measured one hours post reflow at 25°C.

Noted: All electrical function test is conducted after PCB mounted.

## 3、 Thermal Derating

TLC-LSMD050/50	Maximum ambient operating temperature								
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
Hold Current(A)	0.76	0.67	0.59	0.50	0.42	0.38	0.33	0.29	0.23
Trip Current(A)	1.52	1.34	1.18	1.00	0.84	0.76	0.66	0.58	0.46

## 4、 Solder Reflow Recommendations



Notes: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

## 5、 Package Information

Packing quantity: 1500PCS/Reel

Note: Reel packaging per EIA-481-2 standard

## 6、 Agency Recognition:



Caution: Operation beyond the rated voltage or current may result in rupture electrical arcing or flame. Specifications are subject to change without notice.